AP-600 Plasma System

Bench-Top Plasma Treatment

Features and Benefits

- Touch screen control and graphical user interface give real-time process information
- Flexible shelf architecture allows processing of a wide variety of piece parts, components or carriers
- 13.56 MHz RF generator with automatic matching network delivers excellent process repeatability
- Convenient facility hook-ups for periodic calibration requirements used in validation processes



State-of-the-art plasma treatment in a compact, bench-top configuration

The AP-600 plasma system from Nordson MARCH is designed to deliver exceptionally uniform plasma cleaning and treatment with unmatched ease of operation, reliability and low cost.

The AP-600 plasma system is completely selfcontained, requiring minimal bench space. The system chassis houses the plasma chamber, control electronics, 13.56 MHz RF generator, and the automatic matching network (only the vacuum pump is external to the system). Maintenance access is provided through an interlocked door or removable panels.

The plasma chamber is constructed of highquality aluminum with aluminum fixtures for superior durability. The plasma chamber supports up to 7 removable and adjustable powered or grounded shelves to accommodate a wide range of piece-parts, components, and part carriers including magazines, trays, and boats.

Plasma cleaning, surface activation and adhesion improvement

The AP-600 plasma system is suitable for a wide variety of plasma cleaning, surface activation and adhesion improvement applications. These capabilities are used for semiconductor manufacturing, microelectronic packaging and assembly, and by manufacturers of medical and life science devices.

The AP-600 plasma system can accommodate a wide range of process gases including argon, oxygen, hydrogen, helium, and fluorinated gases. The system comes standard with two electronic mass flow controllers for optimal gas control, with another two available optionally (four total max.).



Specifications: AP-600 Plasma System

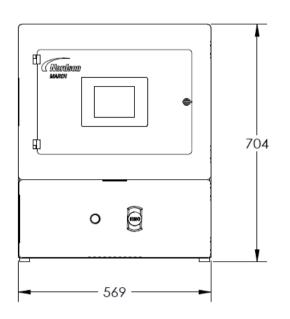
Enclosure	W x D x H – Footprint	569 W x 869 D x 704 H mm
Dimensions		(22.4 W x 32.9 D x 27.7 H in.)
2 1110101010	Net Weight	221 kg (488 lbs)
	Effective Footprint – Clearances	Right, Left, Front – 569 mm (23 in.), Back – 254 mm (10 in.)
Chamber	Dimensions	406 W x 465 D x 267 H mm (16 W x 18.3 D x 10.5 H in.)
	Volume	50 liters (3024 in ³)
	Variable Electrode Configurations	Direct and Downstream
	Number of Shelf Positions	7
	Shelf Pitch	25.4 mm (1 in.)
Electrodes	Powered Electrode Dimensions -	330 W x 330 D (mm); 13 W x 13 D (in.)
	Working Area	
	Ground (Perf.) Electrode	368 W x 330 D (mm); 14.5 W x 13 D (in.)
	Dimensions – Working Area	
	Floating Shelf Dimensions – Working Area	330 W x 330 D (mm); 13 W x 13 D (in.)
RF Power	Standard Wattage	600 W
	Frequency	13.56 MHz
Gas Control	Maximum Number of MFCs	4
Control	PLC Controlled with Touchscreen	
System	Interface	
Remote	PlasmaLINK; ProcessLINK	Optional
Interface		
Vacuum	Rotary Vane Pump Charged for	19.5 CFM at 60Hz wet pump with oil mist eliminator
Pump	Oxygen Service	
Facilities	Power Supply	110VAC, 20A, 50/60Hz, Single Phase, 12AWG, 3-Wire <u>OR</u> 220VAC, 10A, 50/60Hz, Single Phase, 12AWG, 3-Wire
	Process Gas Fitting Size & Type	.25-in. OD Swagelok Tube
	Process Gas Purity	Industrial grade or better
	Process Gas Pressure	Regulated from .69bar (10PSI) min. to 1bar (15PSI) max.
	Purge Gas Fitting Size & Type	.25-in. OD Swagelok Tube
	Purge Gas Purity	Industrial grade Nitrogen or CDA
	Purge Gas Pressure	Regulated from 2 bar (30 psig) min. to 5.5 bar (80 psig) max.
	Pneumatic Valves Fitting Size &	.25-in. OD Swagelok Tube
	Туре	
	Pneumatic Gas Purity	CDA, Oil Free, Dewpoint <=7°C /45°F, Particulate Size <5
	Proventia Cao Processo	micron Regulated from 3.4 bar (50 psig) min. to 5.5 bar (80 psig) max.
	Pneumatic Gas Pressure	
Compliance	Exhaust SEMI S2/S8 compliant	38 mm (1.5 in.) OD Pipe Flange Yes
Compliance	-	
	CE marked	Yes
	Cleanroom compatible	Yes
01. :	SEMI E-10	Yes
Shipping	Crate Dimensions	1575 W x 1143 L x 1143 H mm (62 W x 45 L x 45 H in.)
	Gross Weight	339 kg (750 lbs)

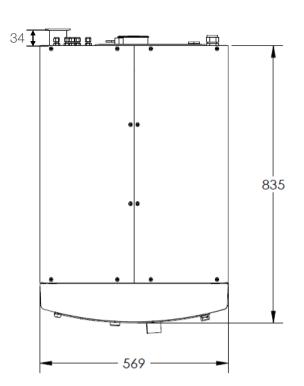
Optional /	Oil Filtration Unit
Ancillary	Nitrogen Generator
Equipment	Hydrogen Delivery Kit



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AP-600 Plasma System Footprint Diagrams

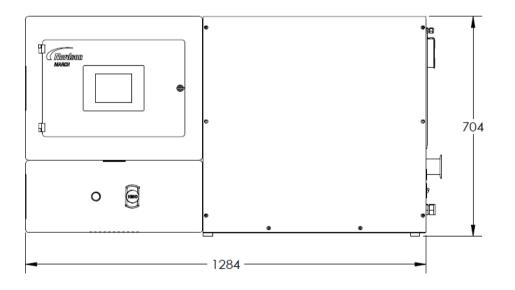




AP-600 – Front View

AP-600 – Top View

All measurements are in millimeters (mm)



AP-600 – Side View with Doors Open



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AP-600 Reformatted Rev. A (2013-06)

Applications: AP-600 Plasma System

Semiconductor and Microelectronic Applications

- Pre-die attach for enhanced die adhesion
- Pre-wire bonding for improved wire bonds
- Pre-mold & encapsulation for reduced delamination
- Pre-flip chip underfill (FCUF) for faster, void-free fluid flow, improved filet height and uniformity, and better adhesion of the underfill material

Medical and Life Science Applications

- Stent & catheter cleaning and bonding
- Enabling adhesion of non-compatible materials
- Tack reduction of silicone molded parts
- Increasing lubricity

For more information, speak with your local representative or contact your regional office.

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